

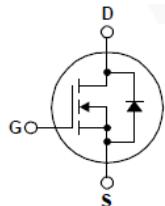
# RTK4N65C

RTK4N65C – N channel Si MOSFET



## Features

- Low gate charge
- Low capacitance fast switching
- Halogen free, RoHS Compliant
- 100% UIS tested

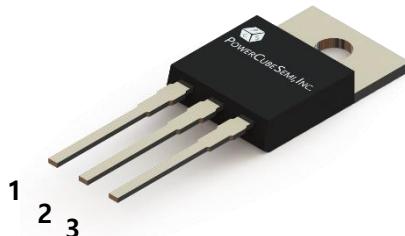


## Applications

- High frequency switching mode power supply
- Electronic ballast
- LED Power supply

## Pin Description

- 1 : Gate  
2 : Drain  
3 : Source



PKG type : TO-220

## Absolute Maximum Ratings $T_C=25^\circ\text{C}$ Unless Otherwise Noted

| Symbol                | Parameter  |   | Value      | Unit |
|-----------------------|--|---|------------|------|
| $V_{DSS}$             | Drain to Source Voltage                          |   | 650        | V    |
| $V_{GSS}$             | Gate to Source Voltage                           |   | $\pm 30$   |      |
| $T_J$                 | Maximum Junction Temperature                     |   | 150        | °C   |
| $T_{STG}$             | Storage Temperature Range                        |   | -55 to 150 | °C   |
| $I_S$                 | Diode Continuous Forward Current                 | $T_C=25^\circ\text{C}$                        | 4          | A    |
| $I_{D, \text{pulse}}$ | 250us Pulse Drain Current Tested                 | $T_C=25^\circ\text{C}$                        | 16         | A    |
| $I_D$                 | Continuous Drain Current ( $V_{GS}=10\text{V}$ ) | $T_C=25^\circ\text{C}$                        | 4          | A    |
|                       |  | $T_C=100^\circ\text{C}$                       | 2.5        |      |
| $P_D$                 | Power dissipation                                | $T_C=25^\circ\text{C}, T_J=150^\circ\text{C}$ | 77         | W    |
| $E_{AS}$              | Avalanche Energy, Single Pulsed                  |   | 198        | mJ   |
| $I_{AS}$              | Avalanche Current, Single Pulsed                 |   | 6.3        | A    |



## Static Characteristics

T<sub>j</sub>=25°C unless otherwise specified

| Symbol              | Parameter                               | Test Condition  | Numerical |      |      | Unit |
|---------------------|---|---|-----------|------|------|------|
|                     |   |   | Min       | Typ. | Max. |      |
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage          | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA              | 650       | -    | -    | V    |
| I <sub>DSS</sub>    | Zero Gate Voltage Drain Current         | V <sub>DS</sub> = 650V, V <sub>GS</sub> = 0V              | -         | -    | 1    | μA   |
| I <sub>GSS</sub>    | Gate-Source Leakage Current             | V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V                | -         | -    | ±100 | nA   |
| V <sub>GS(th)</sub> | Gate Threshold Voltage                  | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = 250μA | 2         | -    | 4    | V    |
| R <sub>DS(ON)</sub> | Static Drain-Source on state resistance | V <sub>GS</sub> = 10V, I <sub>D</sub> = 2A                | -         | 2.5  | 2.7  | Ω    |

## Dynamic Characteristics

| Symbol              | Parameter                    | Test Condition  | Numerical |      |      | Unit |
|---------------------|------------------------------|---|-----------|------|------|------|
|                     |                              |   | Min       | Typ. | Max. |      |
| C <sub>iss</sub>    | Input capacitance            | V <sub>DS</sub> =25V, V <sub>GS</sub> =0V,<br>f=1MHz                                    | -         | 600  | -    | pF   |
| C <sub>oss</sub>    | Output capacitance           |   | -         | 55   | -    |      |
| C <sub>rss</sub>    | Reverse transfer capacitance |   | -         | 3.2  | -    |      |
| t <sub>d(on)</sub>  | Turn-on Delay time           | V <sub>DS</sub> =325V, I <sub>D</sub> =4A,<br>V <sub>GS</sub> =15V, R <sub>G</sub> =10Ω | -         | 12   | -    | ns   |
| T <sub>r</sub>      | Turn-on Rise time            |   | -         | 31   | -    |      |
| t <sub>d(off)</sub> | Turn-off Delay time          |   | -         | 42   | -    |      |
| T <sub>f</sub>      | Turn-off Fall time           |   | -         | 15   | -    |      |

## Gate Charge Characteristics

| Symbol              | Parameter                     | Test Condition  | Numerical |      |      | Unit |
|---------------------|-------------------------------|---|-----------|------|------|------|
|                     |                               |   | Min       | Typ. | Max. |      |
| Q <sub>g(tot)</sub> | Total gate charge at 10V      | V <sub>DS</sub> =520V, I <sub>D</sub> =4A<br>V <sub>GS(on)</sub> =10V | -         | 12   | -    | nC   |
| Q <sub>gs</sub>     | Gate to source gate charge    |   | -         | 3.2  | -    |      |
| Q <sub>gd</sub>     | Gate to drain "Miller" charge |   | -         | 5.1  | -    |      |



## Diode Characteristics

| Symbol    | Parameter  | Test Condition                               | Numerical |      | Unit    |
|-----------|--|--|-----------|------|---------|
|           |  |  | Typ.      | Max. |         |
| $I_S$     | Maximum continuous drain to source diode forward current |  | -         | 4    | A       |
| $I_{SM}$  | Maximum pulsed drain to source diode forward current     |  | -         | 16   | A       |
| $V_{SD}$  | Drain to source diode forward voltage                    | $I_{SD}=4A, V_{GS} = 0V$                     | 0.85      | 1.5  | V       |
| $T_{rr}$  | Reverse recovery time                                    | $I_F=4A, V_R=400V,$<br>$-dI_F/dt=100A/\mu s$ | 282       | -    | ns      |
| $Q_{rr}$  | Reverse recovery charge                                  |  | 1.4       | -    | $\mu C$ |
| $I_{rrm}$ | Reverse recovery current                                 |  | 10        | -    | A       |

## Thermal Characteristics

| Symbol          | Parameter                               | Numerical | Unit          |
|-----------------|---|-----------|---------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case    | 1.62      | $^{\circ}C/W$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 110       |               |

## NOTE

- 1 : Pulse width limited by safe operating area.
- 2 : Calculated continuous current based on maximum allowable junction temperature.
- 3 : Limited by  $T_{Jmax}$ ,  $L=10mH$ ,  $V_{DD}=50V$ ,  $R_G=25\Omega$ , Starting  $T_J=25^{\circ}C$ .
- 4 : Pulse test; Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- 5 : Guaranteed by design, not subjected to production test.

# Typical Characteristics

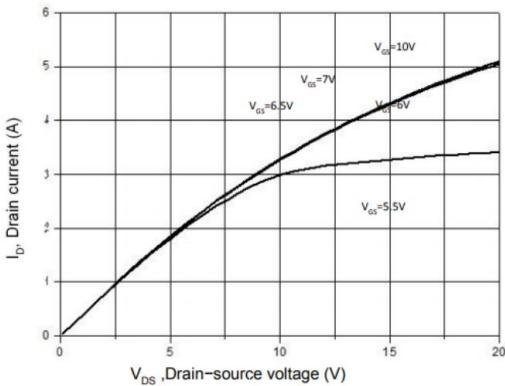


Figure 1. Typical output characteristics

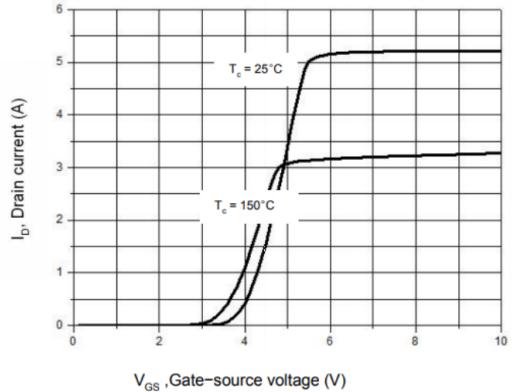


Figure 2. Transfer Characteristics

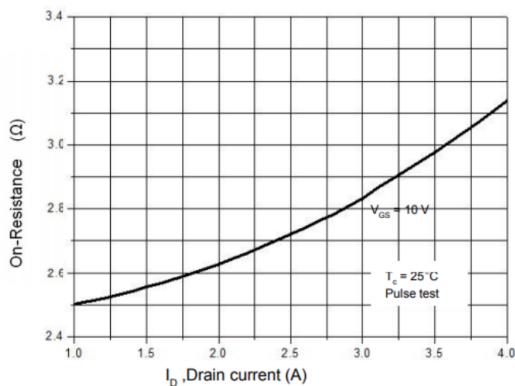


Figure 3. On-resistance variation vs. Drain current

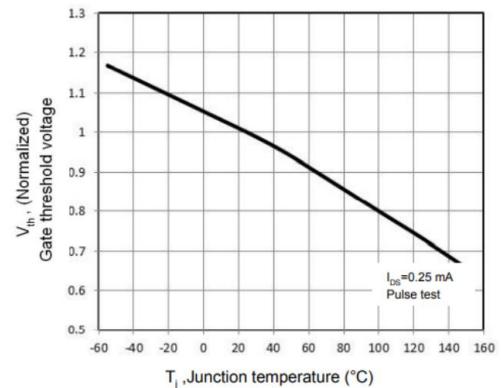


Figure 4. Threshold voltage vs. Temperature

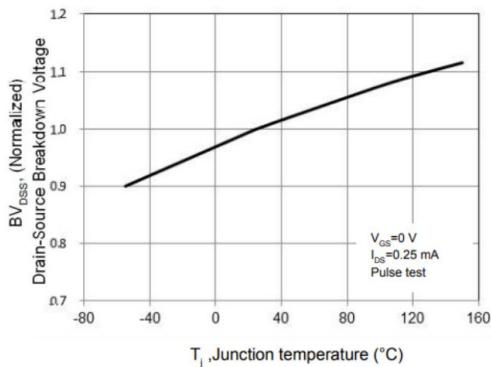


Figure 5. Breakdown Voltage vs. Temperature

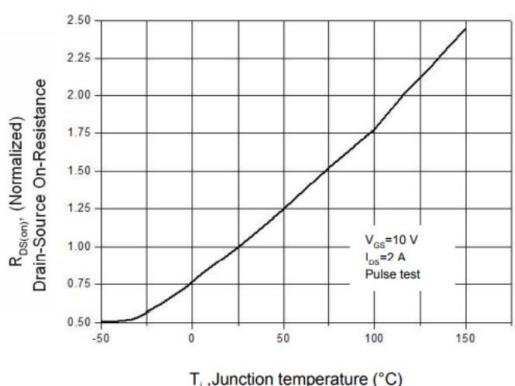


Figure 6. On-resistance vs. Temperature

# Typical Characteristics

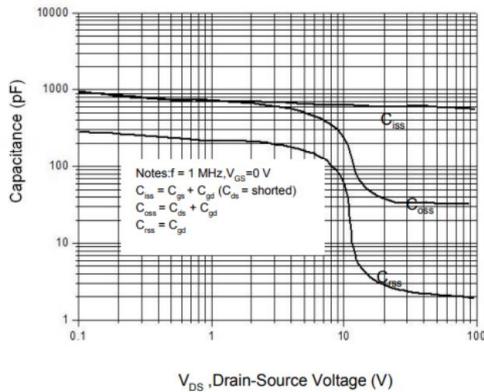


Figure 7. Capacitance Characteristics

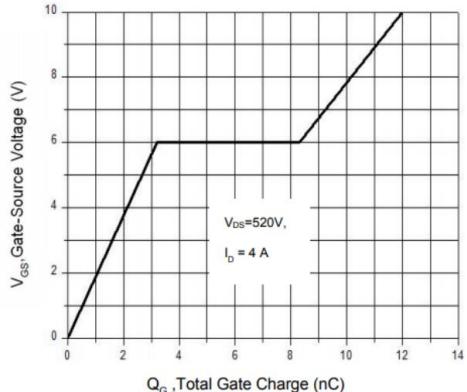


Figure 8. Gate charge characteristics

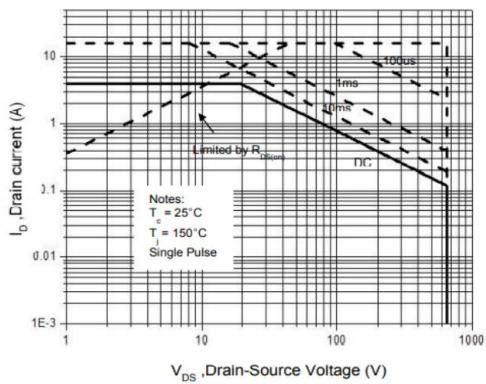


Figure 9. Maximum Safe Operating Area

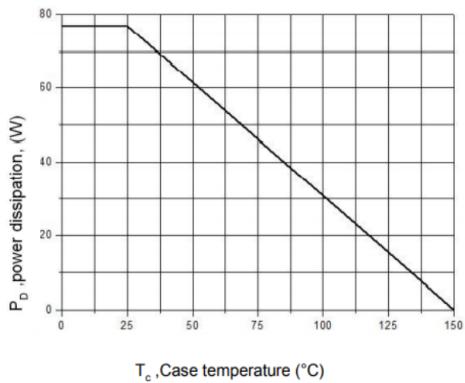


Figure 10. Power dissipation vs. Temperature

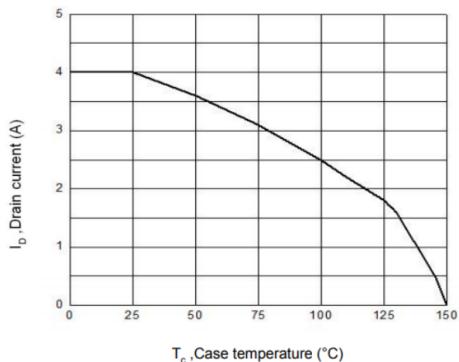


Figure 11. Continuous Drain Current vs. Temperature

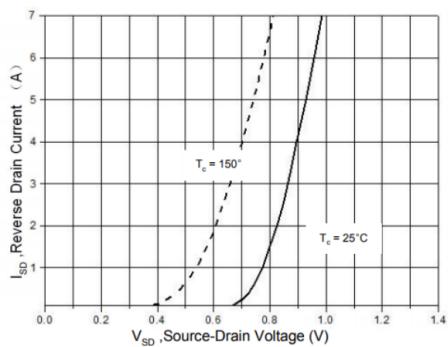
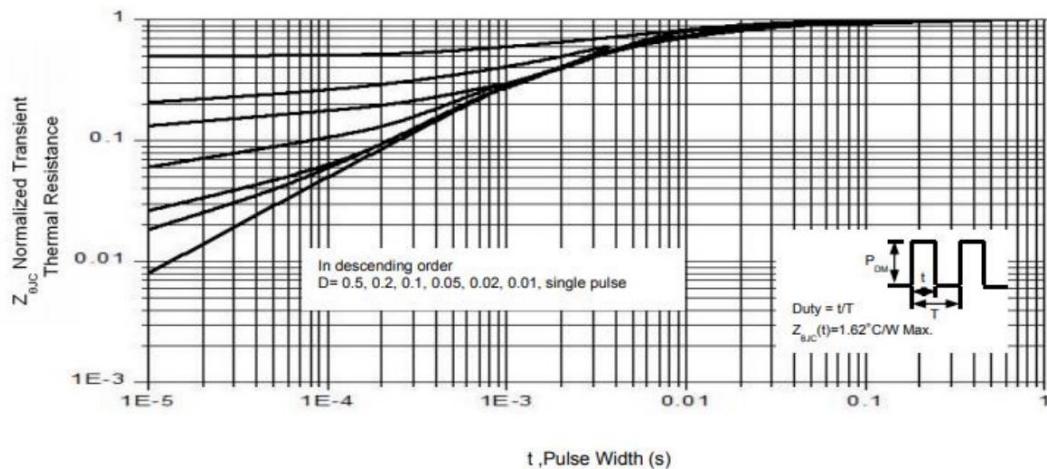


Figure 12. Body diode transfer characteristics

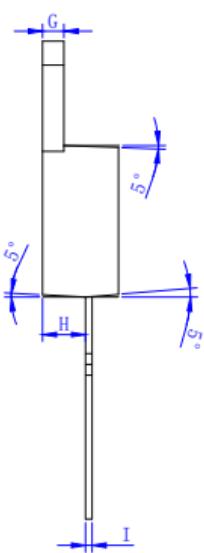
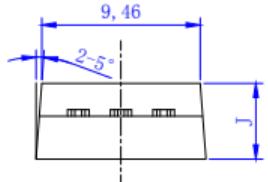
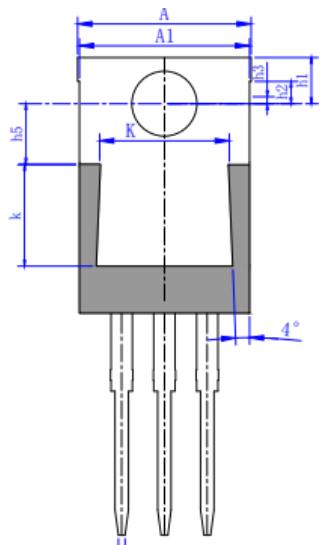
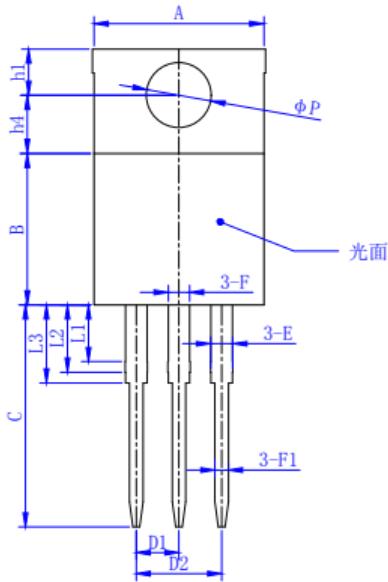
## Typical Characteristics



**Figure 13. Transient Thermal Impedance**

# Package Outline

**Unit : mm**



| SYMBOL | DIMENSIONS |      |      |
|--------|------------|------|------|
|        | MIN        | NOM  | MAX  |
| A      | 10.1       | 10.3 | 10.5 |
| A1     | 10.0       | 10.1 | 10.2 |
| B      | 8.8        | 9.0  | 9.2  |
| C      | 13.0       | 13.3 | 13.5 |
| D1     | 2.54 BSC   |      |      |
| D2     | 5.08 BSC   |      |      |
| E      | 1.27       | 1.32 | 1.40 |
| F      | 1.25       | 1.27 | 1.30 |
| F1     | 0.75       | 0.80 | 0.85 |
| F2     | 0.35       | 0.40 | 0.45 |
| G      | 1.26       | 1.27 | 1.28 |
| H      | 2.40       | 2.55 | 2.70 |
| h1     | 2.70       | 2.74 | 2.80 |
| h2     | 1.27       | 1.32 | 1.37 |
| h3     | 0.40       | 0.42 | 0.45 |
| h4     | 3.40       | 3.45 | 3.50 |
| h5     | 3.60       | 3.63 | 3.65 |
| I      | 0.35       | 0.38 | 0.45 |
| J      | 4.45       | 4.50 | 4.60 |
| K      | 7.60       | 7.70 | 7.80 |
| k      | 6.00       | 6.03 | 6.05 |
| L1     | 3.30       | 3.40 | 3.5  |
| L2     | 3.90       | 4.00 | 4.10 |
| L3     | 4.50       | 4.60 | 4.70 |
| ΦP     | 3.75       | 3.80 | 3.90 |